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B.M.S. College of Engineering, Bengaluru-560019

Autonomous Institute Affiliated to VTU

January 2024 Semester End Main Examinations

Programme: B.E.

Branch: ES – Cluster Elective

Course Code: 19EC7CE2SC

Course: System on Chip

Semester: VII

Duration: 3 hrs.

Max Marks: 100

Instructions: 1. Answer any FIVE full questions, choosing one full question from each unit.
2. Missing data, if any, may be suitably assumed.

Important Note: Completing your answers, compulsorily draw diagonal cross lines on the remaining blank pages. Revealing of identification, appeal to evaluator will be treated as malpractice.			UNIT - I	CO	PO	Marks
	1	a)	Suggest a suitable processor architecture that can be used to carry out the execution of instructions sequentially and discuss its pros and cons.	CO3	PO3	10
		b)	Provide a simplified technology comparison of programmability versus performance using an appropriate graphical representation. Discuss the advantages and disadvantages of hardware and software implementation.	CO3	PO3	10
			OR			
	2	a)	With the help of supportive architecture analyze the importance of VLIW processors.	CO3	PO3	10
		b)	Categorize and analyze the various approaches used for SoC interconnects.	CO3	PO3	10
			UNIT - II			
	3	a)	Summarize the procedure for choosing processors, with a focus on the processor core.	CO 2	PO 2	10
		b)	Classify the instruction sets for basic architecture.	CO 2	PO 2	10
			OR			
	4	a)	Suggest two methods used to solve the branch problem? Discuss in detail.	CO 2	PO 2	10
		b)	Elucidate how a generic vector processor works, highlighting the significance of vector chaining.	CO 2	PO 2	10
			UNIT - III			
	5	a)	Discuss the advantages and disadvantages of water fall and spiral design flow.	CO 1	PO 1	10
		b)	Highlight the significance of Hard IP and Soft IP in SoC.	CO 1	PO 1	10

			UNIT - IV			
6	a)	Elucidate the significance of Interfaces to address the Logic design issues for timing closure.	<i>CO 3</i>	<i>PO 3</i>	10	
	b)	Elaborate on the various ways that power dissipations occur in CMOS circuitry.	<i>CO 1</i>	<i>PO 1</i>	10	
		UNIT - V				
7	a)	Discuss various system level issues and specifications that need to be taken into consideration in order to select an appropriate interconnect architecture, using a supporting diagram of a SoC module in the context of the system.	<i>CO 3</i>	<i>PO 3</i>	10	
	b)	Analyze the different possible bus designs with varying combinations of physical bus widths and arbitration protocols	<i>CO2</i>	<i>PO2</i>	10	
